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09-23-2002



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TS01-788

To the Honorable Commissioner of F

10222536

d original documents or copy thereof.

1. Name of conveying party(ies):

2. Name and address of receiving party(ies):

TZE-LIANG LEE, YUN-SAN HUAN

Name: Taiwan Semiconductor Manufacturing Company

9-13-02

Internal Address:

Additional name(s) or conveying party(ies) attached?  Yes  No

Street Address:

3. Nature of conveyance

Assignment  Merger

121 Park Ave. 3  
Science-Based Industrial Park  
City: Hsin-Chu Zip:  
Country: Taiwan, R.O.C.

Security Agreement  Change of Name

other \_\_\_\_\_

Execution Date: 7/11/02

Additional name(s) & address(es) attached? Yes  No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 7/11/02

A. Patent Application No(s)

B. Patent No.(s)

10243910

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

6. Total no. of applications and patents involved: 1

Name: GEORGE O. SAILE

Internal Address: \_\_\_\_\_

7. Total fee (37 CFR 3.41): \$ 40.00

Enclosed

Street Address: 20 MCINTOSH DRIVE

Authorized to be charged to deposit acct.

City: POUGHKEEPSIE State: NY ZIP: 12603

8. Deposit account number: 19-0033  
(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature .

To the best of my knowledge and belief the foregoing information is true and correct and any attached copy is a true copy of the original document

STEPHEN B. ACKERMAN

Name of Person Signing

Signature

9/13/02

Date

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J1011 U.S. PTO  
10/24/910



For  U.S. and/or  Foreign Rights

For  Application or  U.S. Patent

By  Inventor(s) or  Present Owner

**ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

**ASSIGNOR:**

TZE-LIANG LEE  
Type or print name of ASSIGNOR

Tze-liang Lee  
Address

4F, No. 74, Lane 250, Woo-Ling Rd.,

Hsin-chu, Taiwan, Republic of China  
Nationality

YUN-SAN HUAN  
Type or print name of ASSIGNOR

No 1, Ln 69, Penfung Rd. Hsin-chu, Taiwan  
Address

R.O.C., Republic of China, Taiwan  
Nationality

**ASSIGNEE:**

**Taiwan Semiconductor Manufacturing Co. Ltd.**

**121 Park Ave. 3**

**Science-Based Industrial Park**

**Hsin-Chu, Taiwan, R.O.C.**

**Taiwan, R.O.C.**

Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

*(complete one of the following)*

the entire right, title and interest

an undivided \_\_\_\_\_ percent (\_\_\_\_%) interest for the United States and its territorial possessions  
*(check the following box if foreign rights are also to be assigned)*

and in all foreign countries

in and to any and all improvements which are disclosed in the invention entitled:

**A Novel Pad Structure To Prompt Excellent Bondability For Low-K Intermetal Dielectric Layers**

and which is found in

- (a)  U.S. patent application executed on even date herewith
- (b)  U.S. patent application executed on \_\_\_\_\_
- (c)  U.S. application serial no. \_\_\_\_\_ filed on \_\_\_\_\_
- (d)  U.S. patent no. \_\_\_\_\_ issued \_\_\_\_\_  
*(also check (e) if foreign application(s) is also being assigned)*
- (e)  and any legal equivalent thereof in a foreign country, including the right to claim priority

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute, thereof, and as to letters patent any re-issue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I / We have signed this  
July 11, 2002 (Date of signing)

WARNING Date of signing must be the same as the date of execution of the application if item (a) was checked above

Te-hung Lee  
Signature of ASSIGNOR(S)

Ysmael

\_\_\_\_\_

\_\_\_\_\_

If ASSIGNOR is a legal entity complete the following information

\_\_\_\_\_  
Type or print the name of the above person authorized to sign on behalf of ASSIGNOR

\_\_\_\_\_  
Title

Note: No witnessing, notarization or legalization is necessary, if the assignment is notarized or legalized then it will only be prima facie evidence (35 USC 261). Use next page if notarization is desired.  
Notarization of Legalization Page Added.